



## Product/Process Change Notice - PCN 25\_0119 Rev. B

Analog Devices, Inc. One Analog Way, Wilmington, MA 01887, USA

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. An acceptance or concern response should be submitted to ADI promptly. Any requests for samples of changed material or additional information must be made within 30 days of the notification. In accordance with JEDEC Standard 046, customers should acknowledge receipt of the PCN within 30 days of the PCN delivery. ADI contact information is listed below. Note: Revised fields are indicated by a red field name. See Appendix B for revision history.

**Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change. After the acknowledgment, a lack of additional requests within 90 days constitutes acceptance of the change.**

*Note: Revised fields are indicated by a red field name. See Appendix B for revision history.*

<b>PCN Title:</b>	Bond Wire Change from Gold to Copper
<b>Publication Date:</b>	05-May-2026
<b>Effectivity Date:</b>	07-Aug-2026 <i>(the earliest date that a customer could expect to receive changed material)</i>
<b>Revision Description:</b>	Adding parts.

### Description Of Change:

Change of bond wire from Gold to Copper for LFCSP/SO/TSSOP pkg family built in UTAC (Thailand).

### Reason For Change:

The conversion to Cu wire aligns with industry trend and ADI current and future corporate directives.

Note: UTAC has been in Cu wire production for 10+ years and over billion units shipped to commercial and automotive customers.

### Impact of the change (positive or negative) on fit, form, function & reliability:

This change has no impact on fit, form, function & reliability.

### Product Identification: *(this section will describe how to identify the changed material)*

Analog Device maintains full traceability by device marking/labeling/shipment documents.

### Summary of Supporting Information:

Qualification has been performed per AEC-Q100, Stress Test Qualification for Integrated Circuits. See attached Qualification Results Summary.

### Supporting Documents:

**Attachment 1: Type:** Qualification Results Summary

ADI\_PCN\_25\_0119\_Rev\_B\_Rel. report for Copper Wire Automotive Grade 0 Qualification for LTC Products at UTAC.pdf

**Attachment 2: Type:** Delta Qualification Matrix

ADI\_PCN\_25\_0119\_Rev\_B\_PCN-Delta-Qualification-Matrix-ZVEI-5\_2\_1.xlsm

Note: If applicable, the device material declaration will be updated due to material change.

**ADI Contact Information:**

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

<b>Americas:</b>	<b>Europe:</b>	<b>Japan:</b>	<b>Korea:</b>	<b>Rest of Asia:</b>
<a href="mailto:PCN_Americas@analog.com">PCN_Americas@analog.com</a>	<a href="mailto:PCN_Europe@analog.com">PCN_Europe@analog.com</a>	<a href="mailto:PCN_Japan@analog.com">PCN_Japan@analog.com</a>	<a href="mailto:PCN_Korea@analog.com">PCN_Korea@analog.com</a>	<a href="mailto:PCN_ROA@analog.com">PCN_ROA@analog.com</a>



LTC4380 / LTC4380HMS-4#WTRPBF  
LTC4380 / LTC4380IMS-2#PBF  
LTC4380 / LTC4380IMS-3#TRPBF

LTC4380 / LTC4380IMS-1#PBF  
LTC4380 / LTC4380IMS-2#TRPBF  
LTC4380 / LTC4380IMS-3#WPBF

LTC4380 / LTC4380IMS-1#TRPBF  
LTC4380 / LTC4380IMS-2#WPBF  
LTC4380 / LTC4380IMS-3#WTRPBF

LTC4380 / LTC4380IMS-1#WPBF  
LTC4380 / LTC4380IMS-2#WTRPBF  
LTC4380 / LTC4380IMS-4#WPBF

LTC4380 / LTC4380IMS-1#WTRPBF  
LTC4380 / LTC4380IMS-3#PBF  
LTC4380 / LTC4380IMS-4#WTRPBF

**Appendix B - Revision History:**

<b>Rev</b>	<b>Publish Date</b>	<b>Effectivity Date</b>	<b>Rev Description</b>
Rev. -	17-Apr-2025	20-Jul-2025	Initial Release
Rev. A	06-Jun-2025	08-Sep-2025	
Rev. B	05-May-2026	07-Aug-2026	Adding parts.